

DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: Semiconductor Processing Methods of Forming Devices on a Substrate, Forming Device Arrays on a Substrate, Forming Conductive Lines on a Substrate, and Forming Capacitor Arrays on a Substrate, and Integrated Circuitry, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

PRIOR FOREIGN APPLICATIONS:

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

EM156306369

1 **POWER OF ATTORNEY:**

2 As a named Inventor, I hereby appoint the following attorneys and
3 agent to prosecute this application and transact all business in the
4 Patent and Trademark Office connected therewith: Richard J. St. John,
5 Reg. No. 19,363; David P. Roberts, Reg. No. 23,032; Randy A. Gregory,
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16 (509) 624-4276.

17 I hereby declare that all statements made herein of my own
18 knowledge are true and that all statements made on information and
19 belief are believed to be true; and further that these statements were
20 made with the knowledge that willful false statements and the like so
21 made are punishable by fine or imprisonment, or both, under
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1 Section 1001 of Title 18 of the United States Code and that such willful
2 false statement may jeopardize the validity of the application or any
3 patent issued therefrom.

4 * * * * *

5 Full name of sole inventor: **Werner Juengling**

6 Inventor's Signature: Werner Juengling

7 Date: 23-OCT-96

8 Residence: **Boise, Idaho**

9 Citizenship: **Austria / Europe**

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